PROSEM









iX Series

Unrivalled flexibility for the optimum line configuration

The iX-502 and iX-302 introduce integrated functionality and high-performance levels across a single, common platform offering the best Value of Ownership.

While maintaining their small footprint, the iX-302 and iX-502 can be scaled up/down in small steps to desired output capacity between 49.5K and 165K components per hour (CPH) (rated output), and can handle components from 01005m up to 45 x 45mm² fine-pitch QFP, BGA, μ BGA and CSP packages, and components up to 10.5mm tall.

With up to 260 feeding lanes, they are the most flexible Placement Systems in the industry.





LED ASSEMBLY EQUIPMENT

Low-Cost equipment for LED Industry





HCT-550LW & HCT-610LV represent new class of offline, high speed SMT Mounters for LED industry.

HCT-550LW reaches real speeds up to 45,000CPH on LED Tube lights with vision alignment while HCT-860L can reach up to 250,000CPH.

HCT-610LV is a path-breaking new introduction for DOBs and LED PCBs, capable of reaching 35,000CPH on DOBs and 45,000CPH on LED PCBs.

HCT-330SV(LV) and HCT-530SV(LV) high-speed, entry-level semi-auto (LV—in-line) are ideal for low investment startups with one machine for LED PCBs and LED Drivers.

SMT PRINTING SOLUTIONS

High-Quality equipment for Electronics Industry

HP-500 is one of the most accurate low-cost SMT Solder Paste/Glue Printer in the industry.

Independent floating print heads ensures high repeatability.

With a fixed cycle time of less than 8s, and $25\mu m$ accuracy, it fits most applications easily.

Programmable Under-stencil cleaning modes (Dry/Wet/Vacuum) and 2D Inspection are available as standard functions making it extremely versatile.

Glue Dispensing option can be Field Retrofitted if required for special applications.

CL-1200 is also available for 1200mm applications.





PROCESS EQUIPMENT

Semi-Auto Printer, Reflow Ovens & BHS



Reflow Ovens & BHS

Equipment For All Applications

PROSEM offers a complete range of Process Equipment from JAGUAR, including Semi-Automatic Printers, Reflow Ovens and Board Handling Systems for all applications.

Reflow Ovens are available in 3 different ranges — Economic Series (M-Series), High Quality Series (F-Series) and Dual Lane Ovens (R-Series).

Jaguar Ovens have been specially designed for different applications starting from LED Industry, up to applications with tight process windows such as Medical, IT, Defense, etc.

Board Handling Equipment such as Loaders, Unloaders, Conveyors, etc. are also available for all applications.

Saki

INSPECTION EQUIPMENT

High Quality Affordable Inspection Systems

PROSEM offers High Quality Automated Inspection Systems from SAKI.

Automated Optical Inspection Systems include Desktop as well as Inline 2D AOIs, Inline 3D AOIs and Inline 3D Solder Paste Inspection Systems.

High End X-Ray Inspection Systems are also available 3D Component Level Defect Analysis.

Large Product Range available for variety of applications.





REFURBISHED EQUIPMENT

High Quality SMT Equipment at a fraction of cost

PROSEM offers Fully Refurbished SMT Equipment with quality comparable to brand new equipment at a fraction of a cost.

We provide SMT Line solutions for all volumes, applications and budgets.

Equipment available from 5,000CPH up to more than 100,000 CPH outputs for various kinds of applications such as LED, Energy Meters, Chargers, Motherboards, and many more applications.

All equipment are refurbished using best machines and tools by highly qualified engineers. All equipment are supplied with warranty providing our customers complete peace of mind.











Placement Robot





Placement Quality

Up to 130 Kcph

Practical Output

Up to 260

Part Numbers Handling (8mm) $\pm 35 \mu m$

High Placement Accuracy @ 3σ

Only TRUE Bare Die Handling Scalable Platform Capability

Real-Time Placement Force Control

1.5-8N

Fully Controlled Pick & Place Process







Features

Parameter
Less Than 1 DPM Placement Quality — Best In The Industry
Best Output Over All Applications (Approx. 6,500CPH Per Robot)*
High Feeder Count for Common Setups, Minimizing Changeovers
Continuous Monitoring of Component – Pick Up to Placement
Scale Up or Scale Down Production Volumes in Minutes
No Line Layout Change for Adding/Removing Robots
0201m and Bare Die Handling Capability on Standard Machine
Patented Real Time Placement Force Control
Lowest Energy Consumption

Parameter	iX-302	iX-502
Rated Speed	8,250CPH per Robot	
Accuracy @ Cpk>1	35µm for Passiv	es, 25µm for ICs
Component Size	0.25x0.125mm (02	201m) ~ 45x45mm
Max. Component Height	10.5mm (Optional 12mm)	
Placement Force	Programmable from 1.5 to 8N	
Max. PCB Size	475 x 390mm	515 x 390mm
Max. Optional PCB Size	1,500mm	
Feeding Positions (8mm)	156 (Twin Tape)	260 (Twin Tape)
Footprint (L x W)	2,760 x 1,705mm	3,720 x 1,705mm

^{*} Real Placement Outputs can be simulated based on customer's products with ±5% accuracy









Single Placement Head

Dual Lane System





Intelligent Feeders

High Accuracy Head





Placement Quality

Real-Time
Placement Force Control

Up to 51
Kcph

Practical Output of T4* Dual Lane

Fully Controlled Pick & Place Process

Up to **162**

Part Numbers Handling (8mm)

Bare Die Handling Capability ±25µm

High Placement Accuracy (H1)

> Repairable Toolbits



Up to 40N



Features

Parameter
Less Than 1 DPM Placement Quality — Best In The Industry
Lightweight Graphite Axes for High Accuracy at High Speeds
High Feeder Count for Common Setups, Minimizing Changeovers
Continuous Monitoring of Component — Pick Up to Placement
Different Modes of Production (Dual Lane) for Wide Applications
Control Complete Line from Single Master Module
01005 and Bare Die Handling Capability on Standard Machine
Patented Real Time Placement Force Control
PTH, Press Fit Connectors & 50mm Height Capability (H1)

Parameter	T4 T2	H1
IPC9850/9850A Output	51KCPH 24.3KCPH	7.1KCPH
Accuracy @ Cpk>1	40μm for passives, 25μm for ICs	
Min. Component Size	0.4x0.2mm (01005)	0.6x0.3mm(0201)
Max. Component Size	45 x 45mm	120 x 52mm
Max. Component Height	15mm	25mm
Placement Force	1.5-8N	4.0-60N
Max. PCB Size	555 x 558mm — Single Lane ; 555 x 254mm — Dual Lane	
Feeding Positions (8mm)	162 (Twin Tape)	
Footprint (L x W)	1,170 x 1,855mm	

^{*} Real Placement Outputs can be simulated based on customer's products with ±5% accuracy











Precise 10 Nozzle Design

Electronic Feeders





Auto Nozzle Changer

In-Line Conveyor

55Kcph 45Kcph#

Rated Speed/ Real Speed

> Placement Accuracy

> > $\pm 50 \mu \text{m}$

26

Electronic Feeder Positions (12mm)

Tall Component Support

18_{mm}

0603~ 10mm²

Large Component Range

Large Size PCB Handling

600mm

1 ST in its

class

Auto Nozzle Changer

Lowest Cost of Ownership

<\$40K

Features

Parameter	Details
Vision Parameters	Body Size LED Size LED Orientation Resistor/Capacitor Size IC Size IC Orientation etc.
Alignment Type	Vision Alignment by Camera
Auto Nozzle Change	Higher Speed for Larger Components
Motion System	High Precision Ball Screw System
PCB Transport	600mm long Transport Table
Feeder Type	Electronic Tape Feeders
High Components	Up to 18mm High Components (ELCOs) for DOB application

Parameter	Value
Placement Speed (Rated) Real with Vision	55,000 CPH 45,000 CPH*1 35,000 CPH*2
Feeder Positions	26 (12mm equivalent)
Placement Accuracy	±50μm
PCB Handling	50x50mm ~ 600x500mm
Component Handling	0603 ~ 10mm ²
Feeding Types	8mm, 12mm, 16mm, 24mm Tape, Stick
Operating System	Windows 7
Dimensions Weight	1,230*1,350*1,360mm 1,500kg

^{*1}Real Speed on LED Lamp; *2Real Speed on DOB PCB

M HCT-800L







Precise Head Design

Linear Motor





Electronic Feeders

Auto Nozzle Changer



32к 26.8к

Rated Speed/ IPC9850 Speed (CPH)

> Placement Accuracy

 $\pm 50 \mu \text{m}$

70*

Electronic Feeder Positions

Automatic Conveyor Width Adjustment

0201~ 35mm²

Large Component Range

Smart Nozzle Recognition System



Maintenance Free Linear Motors

Lowest Cost of Ownership





Features

Parameter	Details
Vision Parameters	Body Size Lead/Ball Qty. Lead/Ball Size/Diameter Lead/Ball Pitch etc.
Alignment Type	On-The-Fly Head Camera (<10x8mm) & Fixed Camera (<30mm)
Motion System	Linear Motors for X and Y Axes
Feeding Options	Tape, Stick & Tray
Feeder Type	Electronic Tape Feeders, Stick Feeder
Tray Handling	Up to 2 Full JEDEC Trays
Nozzle Change	Automatic Nozzle Changer with Smart Nozzle Recognition System

Parameter	Value
Placement Speed Optimum IPC 9850	32,000 CPH 26,800 CPH
Feeder Positions	35 (Front, Std.) 35 (Rear, Opt.)
Placement Accuracy	±50μm
PCB Handling	50x50mm ~ 500x350mm
Component Handling	0201 ~ 30mm ²
Operating System	Windows 7
Dimensions Weight	1,150*1,370*1,500mm 1,500kg

^{* 35} Position Front Side Feeder Station (Standard) + 35 Position Rear Side Feeder Station (Optional)











Precise 10 Nozzle Design

Electronic Feeders





Auto Nozzle Changer

In-Line Conveyor

55Kcph 45Kcph#

Rated Speed/ Real Speed

> Placement Accuracy

> > $\pm 50 \mu m$

26

Electronic Feeder Positions (12mm)

Tall Component Support

18 mm

0603~ 10mm²

Large Component Range

Large Size PCB Handling

1.2m

1ST in its

class

Auto Nozzle Changer

Lowest Cost of Ownership

<\$40K

Features

Parameter	Details
Vision Parameters	Body Size LED Size LED Orientation Resistor/Capacitor Size IC Size IC Orientation etc.
Alignment Type	Vision Alignment by Camera
Auto Nozzle Change	Higher Speed for Larger Components
Motion System	High Precision Ball Screw System
PCB Transport	1,200mm long Transport Table
Feeder Type	Electronic Tape Feeders
High Components	Up to 18mm High Components (ELCOs) for DOB application

Parameter	Value
Placement Speed (Rated) Real with Vision	55,000 CPH 45,000 CPH#
Feeder Positions	26 (12mm equivalent)
Placement Accuracy	±50μm
PCB Handling	50x50mm ~ 1,200x500mm
Component Handling	0603 ~ 10mm ² (Up to 18mm Height)
Feeding Types	8mm, 12mm, 16mm, 24mm Tape, Stick
Operating System	Windows 7
Dimensions Weight	2,050*1,350*1,360mm 1,500kg

[#] Real Speed on an LED Tube Light PCB with Vision Alignment









FACTS

42 Kcpl	h
35 Kcpł	ا# #

Rated Speed/ Real Speed

Placement Accuracy

 $\pm 50 \mu m$

20

Electronic Feeder Positions (12mm)

No Feeder Related Downtime

0

0603~ 10mm²

Easy Maintenance

Large Component Range

Large Size PCB Handling

1.2m

1ST in its class

In-Line Conveyor

Rigid Marble Base

Lowest Cost of Ownership

<\$40K

Features

Parameter	Details
Vision Parameters	Body Size LED Size LED Orientation Resistor/Capacitor Size IC Size IC Orientation etc.
Alignment Type	Vision Alignment by Camera
High Speed Mode	Higher Speed without Vision
Motion System	High Precision Ball Screw System
PCB Transport	1,200mm long Transport Table
Feeder Type	Electronic Tape Feeders

Parameter	Value
Placement Speed (Rated) Real with Vision	42,000 CPH 35,000 CPH#
Feeder Positions	20 (12mm equivalent)
Placement Accuracy	±50μm
PCB Handling	50x50mm ~ 1,200x380mm
Component Handling	0603 ~ 10mm ²
Feeding Types	8mm, 12mm, 16mm
Operating System	Windows 7
Dimensions Weight	2,000*1,150*1,400mm 1,680kg

[#] Real Speed on an LED Tube Light PCB with Vision Alignment



IN-LINE ULTRA HIGH SPEED LONG BOARD LED MOUNTER







Up to 32 Head Design

Electronic Feeders





Easy Setup

Auto Conveyor Width



265K*

Placement Speed (CPH)

Maintenance Free Linear Motor

Up to 64

Electronic Feeder Positions (8/12mm)

Automatic Conveyor Width Adjustment

0603~ 8mm^2

Large Component Range

Large Size PCB

Handling

1.2m



Intuitive User-Friendly GUI

Lowest Cost of Ownership

<\$65K

Features

Parameter	Details
Operation Method	Group Pick - Group Place
Motion System	Maintenance Free Linear Motor
Changeover Time	Less than 30 mins
PCB Transport	1,200mm Long In-Line Conveyor
Feeder Type	Electronic Tape Feeders
Cameras	5 pcs for Machine Setting & Fiducials
Flexibility	Customizable No. of Placement Heads

Parameter	Value
Placement Speed (Rated)	265,000 CPH
Feeder Positions	Up to 64 (8/12mm equivalent)
PCB Handling	50x150mm ~ 1,200x300mm
Component Handling	0603 ~ 8mm ²
Feeding Types	8mm, 12mm, 16mm Tape
Operating System	Windows 7
Dimensions Weight	2,350*2,450*1,425mm 1,500kg

^{*} Real Speed on an LED Tube Light PCB if all 64 Heads Used









Low Maintenance

In-Line Conveyor

Maintenance Free Linear Motor

40Kcph 32Kcph#

Rated Speed/ Real Speed

> Placement Accuracy

> > $\pm 50 \mu m$

20

Electronic Feeder Positions (12mm)

Maintenance Free Linear Motor

0603~ 10mm²

Large Component Range

Large Size PCB Handling

1.2m

1ST in its

Rigid Marble Base

class

Lowest Cost of Ownership

<\$40K

Features

Parameter	Details
Vision Parameters	Body Size LED Size LED Orientation Resistor/Capacitor Size IC Size IC Orientation etc.
Alignment Type	Vision Alignment by Camera
LED Scanning	Pre-placed LED Scanning ensuring perfect placement of LENS
Motion System	High Precision Linear Motors
PCB Transport	1,200mm long Transport Table
Feeder Type	Electronic Tape Feeders

Parameter	Value
Rated Speed (LED) Rated Speed (LENS)	40,000 CPH 18,000 CPH
eeder Positions	20 (12mm equivalent) Vibratory LENS Feeder
Placement Accuracy	±30µm
PCB Handling	50x50mm ~ 1,200x460mm
Component Handling	0603 ~ 10mm ² , Height 12mm
Operating System	Windows 7
Dimensions Weight	2,000*1,400*1,400mm 1,680kg

[#] Real Speed on an LED Tube Light PCB with Vision Alignment











Precise 6/8 Nozzle Design

Electronic Feeders





Easy Maintenance

1,500mm Capability

45Kcph 41Kcph#

Rated Speed/ Real Speed

> Placement Accuracy

> > $\pm 50 \mu \text{m}$

20

Electronic Feeder Positions (12mm)

No Feeder related Downtime

0

0603~ 10mm²

Large Component Range

Large Size PCB Handling

1.5m

1_{ST} in its

Rigid Marble Base

class

Lowest Cost of Ownership

<\$35K

Features

Parameter	Details
Vision Parameters	Body Size LED Size LED Orientation Resistor/Capacitor Size IC Size IC Orientation etc.
Alignment Type	Vision Alignment by Camera
Motion System	High Precision Ball Screw System
PCB Transport	1,500mm long Transport Table
In-Line Version	330LV and 530LV Available
Feeder Type	Electronic Tape Feeders
Non-Stop Mode	Non-Stop Production for Small PCBs

Parameter	HCT-330SV	HCT-530SV	
Placement Speed (Rated) Real with Vision	36,000 CPH 34,000 CPH	45,000 CPH 41,000 CPH	
Feeder Positions	20	20	
Placement Accuracy	±50μm		
PCB Handling	50x50mm ~ 1,500x400mm		
Component Handling	0603 ~	0603 ~ 10mm ²	
Feeding Types	8mm, 12mm, 16mm Tape Windows 7		
Operating System			
Dimensions Weight	Approx. 2,000*1,150*1,400mm 1,400Kg		

[#] Real Speed on an LED Tube Light PCB with Vision Alignment



P600





Efficient Drive Control

Flexible Stencil Clamping



Under-Stencil Cleaning

Precise Vision System





High Speed <7.5s Cycle Time#

Closed Loop Comm.

Precise Vision System

Diagonal Warpage

Allowance

High Speed Underside Cleaning

Compact Machine

Compact Machine Size SMEMA Interface

Lowest Cost of Ownership







1%

<1.2m

Features

Parameter
Floating Print Head
High Accuracy Alignment Camera with Telecentric Lens
Low Core Cycle Time
2D Vision Inspection & Analysis with Texture-based Image Recognition
Closed Loop Communication with SPI
StencilVision TM – Check Stencil & Enable Cleaning Automatically
Programmable Cleaning Mode (Dry Wet Vacuum)
SMEMA Compatibility

opcomoditions	
Parameter	Value
Max. PCB Size	600*350mm
Stencil Size	370*400mm ~ 800*800mm
Allowed Warpage	Up to 1% Diagonal Length
Transport Speed	100 ~ 1,500mm/s (Programmable)
Squeegee Speed	10 ~ 200mm/s (Programmable)
Printing Accuracy	±15μm @ 6σ
Cycle Time	<7.5s#
Power	220VAC, 1φ, 50/60Hz 1.5KW
Dimensions	1,150*1,450*1,500mm

[#] Core Cycle Time (Excluding Printing & Cleaning Time)



HP-500





2D Inspection

Flexible Stencil Clamping



Under-Stencil Cleaning



Vision System





High Speed <8s Cycle Time#

Allowable PCB Weight

5Kg



2D Inspection (PCB & Stencil)

Diagonal Warpage Allowance

1%



High Speed **Underside Cleaning**

Highly Accurate Print Quality

 $\pm 25 \mu m$



SMEMA Interface

Lowest Cost of Ownership

<\$35K

Features

Parameter	
Floating Print Head With Two Independent Motors	
High Accuracy Alignment Camera	
Low Cycle Time	
High Speed Under-Stencil Cleaning	
Single Stage High Speed Conveyor	
Programmable Cleaning Mode (Dry Wet Vacuum)	
2D Inspection System (Paste Coverage & Stencil Aperture	Check)
Large Alignment Range (X,Y = \pm 7mm θ = 2.0°)	
SMEMA Compatibility	

Parameter	Value
Max. PCB Size	500*340mm*
Stencil Size	470*370mm ~ 820*737mm
Allowed Warpage	Up to 1% Diagonal Length
Transport Speed	100 ~ 1,500mm/s (Programmable)
Squeegee Speed	10 ~ 200mm/s (Programmable)
Printing Accuracy	±25μm @ 6σ
Cycle Time	<8s
Power	220VAC, 1φ, 50/60Hz 1.5KW
Dimensions	1,250*1,440*1,505mm

[#] Excluding Printing Time *600mm PCB Length available in HP-600









2D Inspection

Patented Granite Structure





Under-Stencil Cleaning

Advanced Vision System



High Speed <12s Cycle Time#

Allowable PCB Weight

5Kg



2D Inspection (PCB & Stencil)

Diagonal Warpage Allowance

1%



High Speed Underside Cleaning

Highly Accurate Print Quality

±25µm



SMEMA Interface

Lowest Cost of Ownership

<\$55K

Features

Parameter
Floating Print Head With Two Independent Motors
High Accuracy Alignment Camera
Low Cycle Time
High Speed Under-Stencil Cleaning
Single Stage High Speed Conveyor
Programmable Cleaning Mode (Dry Wet Vacuum)
2D Inspection System (Paste Coverage & Stencil Aperture Check)
Large Alignment Range (X,Y = ± 7 mm $\theta = 2.0^{\circ}$)
SMEMA Compatibility

Parameter	Value
Max. PCB Size	1,200*360mm
Stencil Size	1,300*300mm ~ 1,500*737mm
Allowed Warpage	Up to 1% Diagonal Length
Transport Speed	100 ~ 1,500mm/s (Programmable)
Squeegee Speed	10 ~ 200mm/s (Programmable)
Printing Accuracy	±25μm @ 6σ
Cycle Time	<12s
Power	220VAC, 1φ, 50/60Hz 1.5KW
Dimensions	2,220*1,230*1,525mm

[#] Excluding Printing Time



ECONOMICAL SERIES LEAD-FREE REFLOW OVENS (6,8,10 ZONES)





Mesh + Chain Transport

Efficient Thermal Design





Auto Chain Lubrication

Fume Extraction System





Air Convection
Top & Bottom

Running Power Consumption

<7kW



Internal Cooling Zone

Temperature Accuracy

±1°C



PC Control

In-Built Temperature Profiler





Dual Side SMD PCB Handling

Lowest Cost of Ownership



Features

Parameter	
Forced Air Convection on Top & Bottom Zones	
1 Forced-Air Cooling Zone	
Chain Transport for Dual-Side SMD PCB Handling	
Windows 7 Based PC Control	
In-built Temperature Profiler	
Low Power Consumption	
High Quality Heat Insulation	
Low/High Abnormal Temperature Alarm	
Lead Free Ready	

Specifications (for M6)

Parameter	Value
Heating Zones	6 Top + 6 Bottom Heating Zones
Heating Length	2,500mm
Cooling Zone	1 Zone, 300mm
PCB Transport	Mesh + Chain Transport
Transport Speed	100 ~ 2,000mm/min
Max. PCB Width	300mm (Chain)
Warm-Up Time	Approx. 20 minutes
Power Consumption	Start up Running - ~18kW 4-7kW
Dimensions Weight	3,600*1,100*1,490mm 900Kg

[#] Please contact your local sales representative for 8/10 zones models. * Price indicated for 6 zone model.

HIGH QUALITY LEAD-FREE REFLOW OVENS (8,10 ZONES)







Mesh + Chain Transport

Efficient Thermal Design





Fume Extraction System

Wide Range of Options





Air Convection
Top & Bottom

Running Power Consumption

Internal Cooling Zone

Temperature Accuracy

±1°C



PC Control

In-Built Temperature

Profiler

Dual Side SMD PCB Handling

Lowest Cost of Ownership





Features

Parameter	
Forced Air Convection on Top & Bottom Zones	
2 Forced-Air Cooling Zones	
Chain Transport for Dual-Side SMD PCB Handling	
Windows 7 Based PC Control	
In-built Temperature Profiler	
Low Power Consumption	
High Quality Heat Insulation	
Low/High Abnormal Temperature Alarm	
Dual Lane, N ₂ Options Available	

Specifications (for F8)

Parameter	Value
Heating Zones	8 Top + 8 Bottom Heating Zones
Heating Length	3,121mm
Cooling Zone	2 Zones, 345mm each
PCB Transport	Mesh + Chain Transport
Transport Speed	100 ~ 2,000mm/min
Max. PCB Width	400mm (Chain)
Warm-Up Time	Approx. 20 minutes
Power Consumption	Start up Running - ~40kW ~8kW
Dimensions Weight	5,300*1,320*1,490mm 1,800Kg

[#] Please contact your local sales representative for 10/12 zones models. * Price indicated for 8 zone model.

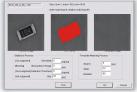
saki **2D A0I**

INLINE 2D HIGH RESOLUTION HIGH SPEED AOI









Complex PCB Inspection

Rotated Component Support





User Friendly Operation Extra Component Detection





Line Color CCD Camera

High Resolution





LED **Lighting Source**

Multi-Stage Inspection





Color Inspection

2D Barcode Option





High Speed Inspection

Lowest Cost of Ownership



Features

Parameter
Line Scan Technology — Core Technology of Saki
Tele-centric Lens for Distortion-Free Images
Coaxial Parallel Light Illumination for Eliminating Shadow
20 Different Combinations for Best Inspection Results
Multiple Stage Inspection (Pre/Post Reflow/Wave)
Flat Belt PCB Transfer
Automatic Conveyor Width Adjustment
No Camera, Lens, Gantry Maintenance Costs
MTBF More Than 180 Months
Top + Bottom Side Scanning At The Same Time#4

Parameter	BF-Frontier II	BF-Tristar II	
Max. PCB Size	460*500mm	250*330mm	
Inspection Parameters	Presence/Absence, Misalignment, Tombstone, Reverse, Polarity, Bridge, Foreign Material, Solder Absence, Insufficient Solder, Lifted Lead, Lifted Chip, Fillet Defect		
Camera	Line Color CCD Camera		
Tact Time	21s ^{#1}	21s ^{#2}	
Resolution	18µm	10μm	
Lens Type	Tele-Centric Lens		
Dimensions (mm)	850*1,340*1,230	850*1,295*1,130	

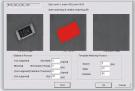
 $^{^{\#1}}$ For PCB Size 460 x 500mm. $^{\#2}$ For PCB Size 250*330mm. For smaller PCBs, Cycle time will be shorter. $^{\#3}$ Price Indication for BF-Frontier II. $^{\#4}$ This feature is available only on BF-Tristar II

DESKTOP 2D HIGH RESOLUTION HIGH SPEED AOI









Complex PCB Inspection

Rotated Component Support





User Friendly Operation Extra Component Detection





Line Color CCD Camera

> High Resolution





LED **Lighting Source**

Multi-Stage Inspection





Color Inspection

2D Barcode Option





High Speed Inspection

Lowest Cost of Ownership



Features

Parameter
Line Scan Technology - Core Technology of Saki
Tele-centric Lens for Distortion-Free Images
Coaxial Parallel Light Illumination for Eliminating Shadows
20 Different Combinations for Best Inspection Results
Multiple Stage Inspection (Pre/Post Reflow/Wave)
Flat Belt PCB Transfer
No Camera, Lens, Gantry Maintenance Costs
MTBF More Than 180 Months
2D Barcode Recognition Option

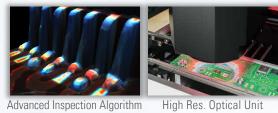
Parameter	BF-Sirius	BF-Comet	
Max. PCB Size	460*500mm	460*500mm 250*330mm	
Inspection Parameters	Presence/Absence, Misalignment, Tombstone, Reverse, Polarity, Bridge, Foreign Material, Insufficient/No Solder, Lifted Lead/Chip, Fillet Defect		
Camera	Line Color CCD Camera		
Tact Time	18s ^{#1}	18s/13s ^{#2}	
Resolution	18µm	10/18µm	
Lens Type	Tele-Centric Lens		
Dimensions (mm)	800*1,280*600	580*850*452	

^{#1} For PCB Size 460 x 500mm.

^{#2} For PCB Size 250*330mm on BF-Comet10 and BF-Comet18 respectively. For smaller PCBs, Cycle time will be shorter. Includes scanning time.

INLINE 3D HIGH RESOLUTION HIGH SPEED AOI









High Accuracy OCR/OCV

Fujiyama Algorithm





Fringe Pattern Projection

> High Resolution





LED Lighting Source

Multi-Stage Inspection





Color Inspection

2D Barcode Option





High Speed Inspection

Lowest Cost of Ownership



Features

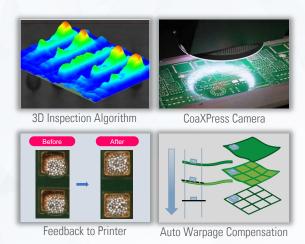
Parameter
High Res. Optical Head with Multi Frequency Digital Projector
CoaXPress Camera for Faster Inspection & Measurement Process
Scalable Optical Resolution of 12µm and 18µm
High Resolution Linear Scale for Accurate Positioning
Multiple Stage Inspection (Pre/Post Reflow/Wave)
Phase Measurement Profilometry for Height Range 1-20µm
Feedback to Pick & Place
Automatic Conveyor Width Adjustment
Through-hole Device Solder Inspection Verification (Fujiyama Algorithm)

Parameter	3Di L Series	
Max. PCB Size	500*510mm	
Inspection Parameters	Presence/Absence, Misalignment, Tombstone, Reverse, Polarity, Bridge, Foreign Material, Solder Absence, Insufficient Solder, Lifted Lead, Lifted Chip, Fillet Defect	
Camera	12MP CoaXPress Camera	
Resolution	12μm 18μm	
Recognition Speed (mm ² /s)	3,600 5,700	
FOV Size (mm)	36*42 41.5*41.5	
Dimensions (mm)	1,040*1,440*1,500	

^{#1} For 3Di-LS2-L

INLINE 3D HIGH RESOLUTION HIGH SPEED SPI









Fringe Pattern
Projection

High Resolution





LED Lighting Source

High Quality Camera Optics





Color Inspection

2D Barcode Option





High Speed Inspection

Lowest Cost of Ownership



Features

Parameter
High Resolution Optical Head with Multiple Projectors
CoaXPress Camera for Faster Inspection & Measurement Process
Scalable Optical Resolution of 12 µm and 18 µm
High Resolution Linear Scale for Accurate Positioning
Phase Measurement Profilometry for Height Range 1-20µm
Feedback to Printer
Automatic Conveyor Width Adjustment
Saki Self-Programming (SSP) Software for Fast Programming
Dual Lane Option Available

Parameter	3Si L Series	
Max. PCB Size	500*510mm	
Inspection Parameters	Solder Paste Height, Volume, Area, Bridging, Offset and Shape	
Camera	12MP CoaXPress Camera	
Resolution	12µm 18µm	
Recognition Speed (mm ² /s)	5,500 6,400	
Height Measurement Range	500µm	
Height Resolution	0.1µm	
Dimensions (mm)	1,040*1,440*1,500	











PLC Controlled

LCD Control Panel





Precise Up/Down Cylinder

SMEMA Interface





LCD Control Panel

Selectable Pitch (Loader/Unloader)



Standard Magazine Rack



High Quality Motor

SMEMA Interface



Japanese LM Guides

Lowest Cost of Ownership







Features

Parameter
Automatic Magazine Changeover with User Selectable Pitch
Solid Casted Base for Machine Stability
Dual Pneumatic Clamping for Magazine Alignment
Adjustable Pressure for PCB Pusher Arm
PLC Controlled
LCD for User Parameter Programming
SMEMA Interface for Interconnection Upstream & Downstream
JB-330/390 & Other Board Handling Equipment Also Available

•			
Parameter	JB-250-LD	JN-250-ULD	
Max. PCB Size	250*330mm		
Lift Up/Down Mechanism	Step Selection of 10, 20, 30 & 40mm		
Control System	PLC Based LCD Panel		
Conveyor Height	900±20mm		
Conveyor Direction	Left-Right (Right To Left Available)		
Interface	SMEMA Interface		
Power	1φ, 220VAC, 50/60Hz		
Dimensions (mm)#	900*770*1,250	1,730*770*1,250	

^{*} Magazines not included | # Without Signal Tower









Touch Screen Control

Dual Metal Squeegee





PLC Control

PCB Table Up-Down





PANASONIC Motor

PCB Position Adjustment (X|Y|R)





Japanese LM Guides

Lowest Cost of Ownership



Description	\$400	S600	S1200
Max. PCB Size	400*300mm	600*300mm	1,200*300mm
PCB Thickness	0.2 – 2.0mm		
PCB Positioning System	Reference Pin/Blocks		
PCB Adjustment Range	±10mm in X & Y R adjustment by combination of X & Y		
Printing Accuracy	±0.02mm		
Printing Repeatability	±0.02mm		
Air Pressure	0.4 - 0.6MPa		
Power	1ф, 220VAC, 50/60Hz		
Dimensions	900*700*1,650mm	1,100*700*1,650mm	1,700*700*1,650mm









Dual Lane Transport

Dual Nozzle Structure

540K CPH

Maximum Speed#

Maintenance Free Linear Motor 6.5

Minimum Head Pitch

Infinite PCB

Handling

Sets of Cameras

10

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Application Example Lowest Cost of Ownership

Intuitive User-

Friendly GUI





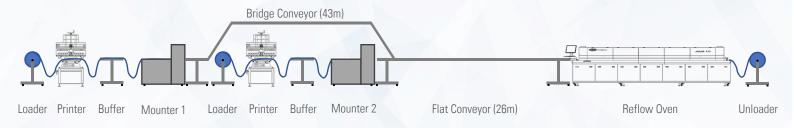
Features

Parameter	Details
High Speed	Highest Output in the Industry for Strip Light SMT Assembly
Adjustable Heads	Adjustable Head and Feeder Pitch to Match PCB Design
Linear Motors	High Power Linear Motors for High Accuracy and High Output
Dual Nozzle Structure	Dual Nozzle Structure Enabling 6.5mm Pitch
No Missing Components	(Optional) Missing Component Mounting Eliminating Manual Rework
Feeder Type	Electronic Tape Feeders

•		
Parameter	L500	L800
Placement Speed	Up to 270KCPH#	Up to 540KCPH#
PCB Handling	Any Length * 280mm	
Feeder Positions	64	128
Nozzles Standard Optional	2 Groups 32/Head, Total 64 38/Head, Total 76	4 Groups 32/Head, Total 128 38/Head, Total 152
PCB Lanes	Single-Lane	Dual-Lane
Head Pitch	Minimum 6.5mm	
Power Air	380V 3¢ 0.5~0.8 MPa	
Dimensions	2,900*2,550*1,550	3,680*2,600*1,650

[#]Real Speed on Strip Light with 6.5mm Pitch, 38 Strips per Panel, 240 LEDs per meter

LED STRIP LIGHT - SMT SOLUTION

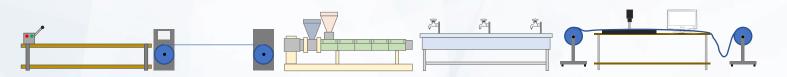


SINGLE LANE SOLUTION



DUAL LANE SOLUTION

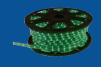
LED STRIP LIGHT - EXTRUSION/DISPENSING

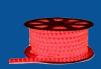


PVC/SILICONE EXTRUSION (UNLIMITED LENGTH)



PU/SILICONE DISPENSING (5/6.5M)















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